

METHOD FOR DRIVING
SOLID-STATE IMAGE PICKUP DEVICE

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BACKGROUND OF THE INVENTION

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1. Technical Field of the Invention

The present invention relates to a method for driving solid-state image pickup devices.

2. Description of the Prior Art

10 When a color VTR (video tape recorder) camera for an interlace signal for the standard TV receiver is used for a solid-state image pickup devices such as a electronic still camera, or an image input device for personal computers, a signal processing for converting the pixel number and the 15 scanning format is required, because the progressive format for monitors of personal computers is different from the interlace format.

Therefore, the progressive format solid-state image pickup 20 devices which can read out all the pixels without the conversion processes are employed for the electronic still camera or the input device for the personal computers.

Nevertheless, the interlace format solid-state image pickup 25 devices are used often, because they can be manufactured by fewer steps, their image cells can be highly integrated, and they can be used also as the color VTR camera, as described in TAKEMURA Hiroo " CCD Camera Technique" Radio Gijutsu Co., Showa 61 (1986) November 3, First Edition, pp 23-30, pp46-50.

There is shown in Figure 7 a plan view of a conventional

interlace solid-state image pickup device with a vertical charge transfer unit wherein signal charges are transferred by double layered electrodes and four phased pulses.

The conventional interlace solid-state image pickup device
5 as shown in Figure 7 comprises photo-electric conversion unit 101, vertical charge transfer unit 102, horizontal charge transfer unit 103, and output circuit 104. Concretely, one step vertical charge transfer unit 102 is connected with two horizontal photo-electric conversion units 101, or in other
10 words, 1/2 step vertical charge transfer unit 102 is connected with one horizontal photo-electric conversion units 101.

There is shown in Figure 8 a plan view of enlarged cells which comprises photoelectric conversion unit 101, vertical charge transfer unit 102, first charge transfer electrode 105, 15 and second charge transfer electrode 106.

There is shown in Figure 9 a cross sectional view of the cells along the lines I-I' of Figure 8. The cell as shown in Figure 9 comprises N⁻ semiconductor substrate 107, P⁻ semiconductor substrate 108, N semiconductor region 109, P⁺ 20 semiconductor 110, first charge transfer electrode 105 of first poly-silicon 111, second charge transfer electrode 106 of second poly-silicon 112, shading film 113 such as aluminum film, insulating film 114, and cover insulating film 115.
The conventional interlace solid-state image pickup device
25 operates under the timing chart as shown in Figure 10.

Firstly, in order to reset the charges in photo-electric conversion unit 101 at t₁, a reverse bias voltage VHsub is applied to N⁻semiconductor substrate 107 as shown in Figure 11. Hereupon, the charges in photo-electric conversion unit

101 are swept out into N semiconductor substrate 107, because N semiconductor region 109 and P semiconductor region 108 become complete depletion layers. Such a structure is generally called a vertical over-flow drain (OVD) 5 structure as described in Journal of Television Society Vol.37, No.10 (1983) pp782 - 787.

Next, a voltage VBsub is applied to N semiconductor substrate 107 to start storing signal charges corresponding to the incident light, while surplus charges which can not be 10 stored in photo-electric conversion unit 101 are excluded into N semiconductor substrate 107 by using vertical OVD. Such an exclusion of the surplus charges is called blooming control.

Next, at the moment t_2 when a prescribed exposure time (t_1-t_2) passes, the incident light is cut off by a cut off means 15 such as a mechanical shutter which is positioned in front of the solid-state image pickup device.

Then, at the time t_4 , signal charges, for example, such as signal charges 11,12,13,31,32,33,51,52,53 in photo-electric conversion unit 101 are read out into vertical charge transfer 20 units 102 which transfer vertically the signal charges line by line into horizontal charge transfer unit 103 which transfers the signal charges horizontally to output them from output circuit 104.

Finally, at the time t_5 , signal charges, for example, such as 25 signal charges 21,22,23,41,42,43,61,62,63 in photo-electric conversion unit 101 are read out into vertical charge transfer units 102 and then outputted likewise from output circuit 104. Thus, the signal charges from all of the pixels for one frame of display can be acquired, as described in TAKEMURA Hiroo "

"CCD Camera Technique" Radio Gijutu Co., Showa 61 (1961)
November 3, First Edition, pp 23-30, pp46-50.

However, the above-mentioned conventional device has a disadvantage that the read out saturation signal decreases
5 with increasing read out cycles wherein the photo-electric conversion unit is read out several times part by part.

SUMMARY OF THE INVENTION

10 Therefore, an object of the present invention is to provide a method, which improves the above-mentioned disadvantage, for driving solid-state image pickup devices.

The method of the present invention is a method for driving a solid-state image pickup device which stores, in a plurality of photo-electric conversion units, signal charges corresponding to an incident light image during a prescribed time period and excludes surplus charges by an electric potential barrier. Further, the solid-state image pickup device reads out, after cutting off the incident light by a cut-off means such as a mechanical shutter, the signal charges by grouping a plurality of the photo-electric conversion unit into a prescribed number of regions. Furthermore, the device outputs the image signal from all of the photo-electric conversion units by repeating the read-out procedures. In the method of the present invention for driving the above-mentioned device, the signal charges are read out by raising up the above-mentioned electric potential after cutting off the incident light.

The solid-state image pickup device may be provided with a

photo-electric conversion unit with a vertical overflow drain (OFD) structure for blooming control which excludes the surplus charges by the electric potential barrier by a voltage applied to the substrate of the vertical OFD structure. In the 5 method of the present invention for driving such a device, the signal charges are read out by raising up the above-mentioned electric potential after cutting off the incident light.

The solid-state image pickup device may also be provided 10 with a photo-electric conversion unit with a horizontal overflow drain (OFD) structure for blooming control which excludes the surplus charges by the electric potential barrier by a voltage applied to the gate of the horizontal OFD structure. In the method of the present invention for driving 15 such a device, the signal charges are read out by raising up the above-mentioned electric potential after cutting off the incident light.

Further, in the method of the present invention, the electric potential during the read-out step may be raised up 20 by a voltage greater than 0.4 V. Further, the electric potential during the read-out step is deeper than an adjacent electric potential which is applied, during the times except the read-out step, to the photo-electric conversion units which are adjacent to those which are being read out. 25 Furthermore, the potential difference between the electric potential during the read-out step and the adjacent electric potential may be greater than 0.4 V.

According to the present invention, the disadvantage that the signal charges decrease depending upon the storage time

is overcome by the first mode of the invention, wherein the substrate voltage VLsub is applied to raise up the potential barrier so that the self-induced drift or the thermal diffusion be suppressed, and then the signal charges are read out from
5 the desired regions of the photo-electric conversion unit into the vertical charge transfer unit.

Futher, according to the present invention, the disadvantage that the signal charges decrease depending upon the storage time is also overcome by the second mode of
10 the invention, wherein the gate voltage VLg of reset transistor 211 is applied to raise up the potential barrier so that the self-induced drift or the thermal diffusion be suppressed, and then the signal charges are read out from the desired regions of the photo-electric conversion unit into
15 the vertical charge transfer unit.

BRIEF EXPLANATION OF THE DRAWINGS

Figure 1 is a timing chart for driving the solid-state image
20 pickup device of the first mode of embodiment of the present invention.

Figure 2 is a potential diagram of the photo-electric conversion unit with the vertical OFD (overflow drain) of the first mode of embodiment of the present invention.

25 Figure 3 is a timing chart for driving the solid-state image pickup device of the second mode of embodiment of the present invention.

Figure 4 is a conceptual plan view of the solid-state image pickup device of the second mode of embodiment of the

present invention.

Figure 5A is a cross sectional view of the photo-electric conversion unit with the horizontal OFD (overflow drain) of the second mode of embodiment of the present invention.

5 Figures 5B, 5C and 5D are potential diagrams of the photo-electric conversion unit with the horizontal OFD (overflow drain) of the second mode of embodiment of the present invention.

10 Figure 6 is a graph showing the relation between the decreasing ratio of saturation signal and the potential difference $\Delta \phi$.

Figure 7 is a schematic plan view of a conventional solid-state image pickup device.

15 Figure 8 is a schematic plan view view of a photo-electric conversion unit of the conventional solid-state image pickup device.

Figure 9 is a cross sectional view along I-I' lines of the photo-electric conversion unit of the conventional solid-state image pickup device.

20 Figure 10 is a timing chart for driving the conventional solid-state image pickup device.

Figure 11 is a potential diagram of the conventional photo-electric conversion unit with the vertical OFD (overflow drain).

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PREFERRED EMBODIMENT OF THE INVENTION

The first mode of embodiment of the present invention is explained, referring to the drawings.

INS 1

The operation of the first mode of the invention is explained, referring to the timing chart as shown in Figure 1, concerning about the interlace solid-state image pickup device with the vertical OFD for the blooming control.

- 5 Firstly, in order to reset the charges in photo-electric conversion unit 101 are reset at t_1 , a reverse bias voltage VH_{sub} is applied to N semiconductor substrate 107 as shown in Figure 2. Hereupon, the charges in photo-electric conversion unit 101 are swept out into N semiconductor substrate 107, because N semiconductor region 109 and P semiconductor region 108 become complete depletion layers.
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- 15 Next, a voltage VB_{sub} is applied to N semiconductor substrate 107 to start storing signal charges corresponding to the incident light, while surplus charges which can not be stored in photo-electric conversion unit 101 are excluded into N semiconductor substrate 107 by using vertical OFD for the blooming control.

- 20 Next, at the moment t_2 when a prescribed exposure time $(t_1 - t_2)$ passes, the incident light is cut off by a cut off means such as a mechanical shutter.

INS 2

- Then, at the time t_3 , a voltage VL_{sub} is applied to N semiconductor substrate 107 to raise up the potential barrier by $\Delta \phi$ of the vertical OFD for the signal charges, whereby the leakage of the signal charges due to the self-induced drift, or the thermal diffusion is suppressed.
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The suppression of decreasing the stored signal charges depends sensitively upon $\Delta \phi$ ($= \phi' - \phi$).

*INS 3
cont*

As shown in Figure 6, The decrease in the signal charges is improved to the negligible level for practical uses, when $\Delta \phi$

is greater than 0.4 V, although $\Delta \phi$ may be more preferably about 0.7 V taking an operation margin into consideration.

a₂ *Ins 2* The electric potential ϕ' is preferably deeper than ϕ_{tg} which is given by the voltage VMcl which is applied, during 5 the times except the read-out step, to second charge transfer electrode 106 in signal read-out portion 120 adjacent to photo-electric conversion unit 101.

When ϕ' becomes equal to or shallower than ϕ_{tg} , the charges stored in photo-electric conversion unit 101 flows 10 through signal read-out portion 120 into vertical charge transfer unit 102. This undesirable flow of charges depends sensitively upon $\Delta \phi'$ ($= \phi' - \phi_{tg}$). The charge flow is suppressed to the negligible level for practical uses, when $\Delta \phi'$ is greater than 0.4 V, although $\Delta \phi'$ may be more 15 preferably about 0.7 V taking an operation margin into consideration.

Ins a₃ Then, at the time t_4 , signal charges, for example, such as signal charges 11,12,13,31,32,33,51,52,53 in photo-electric conversion unit 101 are read out into vertical charge transfer units 102 which transfer vertically the signal charges line by line into horizontal charge transfer unit 103 which transfers the signal charges horizontally to output them from output circuit 104.

Finally, at the time t_5 , signal charges, for example, such as 25 signal charges 21,22,23,41,42,43,61,62,63 in photo-electric conversion unit 101 are read out into vertical charge transfer units 102 and then outputted likewise from output circuit 104. Thus, the signal charges from all of the pixels for one frame of display can be acquired.

The disadvantage that the signal charges decrease depending upon the storage time is overcome by the first mode of the invention, wherein the substrate voltage VLsub is applied to raise up the potential barrier so that the self-induced drift or the thermal diffusion be suppressed, and then the signal charges are read out from the desired regions of the photo-electric conversion unit into the vertical charge transfer unit.

Next, the second mode of embodiment of the present invention is explained, referring to the drawings.

A conceptual plan view of an X-Y addressed solid-state image pickup device is shown in Figure 4.

The X-Y addressed solid-state image pickup device as shown in Figure 4 comprises photo-electric conversion unit 201, vertical shift register 202, horizontal shift register 203, load transistor 204, address line 205, and signal line 206.

As shown in Figure 5A, a cross sectional view of photo-electric conversion unit 201 which comprises P-semiconductor substrate 221, P-semiconductor region 222, P⁺ semiconductor region 223, N semiconductor region 224, N⁺ semiconductor region 225, reset transistor 211, driving transistor 212 for a source follower circuit, and selection transistor 213.

The operation of the second mode of the invention is explained, referring to the timing chart as shown in Figure 3, concerning about the X-Y addressed solid-state image pickup device with the horizontal OFD for the blooming control.

Firstly, in order to reset the charges in photo-electric conversion unit 101 are reset at t₁, a voltage VHg is applied to

reset transistor 211 as shown in Figure 5D. Hereupon, the electric potential of reset transistor becomes deep. Further, the electric potential of N semiconductor region 224 in photo-electric conversion unit 201 set to be equal to the voltage

5 VDD of a voltage source.

Next, as shown in Figure 5C, a voltage VBg is applied to reset transistor 211 in order to start storing signal charges corresponding to the incident light, while surplus charges which can not be stored in photo-electric conversion unit 201

10 are excluded into N⁺ semiconductor region 225 by using horizontal OFD for the blooming control.

Next, at the moment t_2 when a prescribed exposure time ($t_1 - t_2$) passes, the incident light is cut off by a cut off means such as a mechanical shutter.

15 Then, as shown in Figure 5B, at the time t_3 , a voltage VLg is applied to reset transistor 211 to raise up the potential barrier by $\Delta \phi$ of the horizontal OFD for the signal charges, whereby the leakage of the signal charges due to the self-induced drift, or the thermal diffusion is suppressed.

20 The suppression of decreasing the stored signal charges depends sensitively upon $\Delta \phi$ ($= \phi' - \phi$).

The decrease in the signal charges is improved to the negligible level for practical uses, when $\Delta \phi$ is greater than 0.4 V, although $\Delta \phi$ may be more preferably about 0.7 V

25 taking an operation margin into consideration.

$\Delta \phi$ may be preferably about 0.7 V for such a suppression.

Then, at the time t_4 , signal charges, for example, such as signal charges are read out from the odd lines and outputted.

Finally, at the time t_5 , signal charges are read out from the

even lines and then outputted. Thus, the signal charges from all of the pixels for one frame of display can be acquired.

The disadvantage that the signal charges decrease depending upon the storage time is overcome by the second mode of the invention, wherein the gate voltage VLg of reset transistor 211 is applied to raise up the potential barrier so that the self-induced drift or the thermal diffusion be suppressed, then the signal charges are read out from the desired regions of the photo-electric conversion unit into the vertical charge transfer unit.

It should be understood by those skilled in the art that the foregoing and various other changes, omissions, and additions in the form and detail thereof may be made therein without departing from the spirit and scope of the present invention. For example, the present invention is applicable to a device with signal read-out portion 120, although the second mode of embodiment is lack of the signal read-out portion 120 which may be formed adjacent to photo-electric conversion unit 101.